

LEVEL 2

LABORATORY TRAINING ON

SEMICONDUCTOR PACKAGING

CO-ORGANIZED BY



2024



DATES:
06 to 09, JULY 2024



CMTI
Bengaluru

CONTACT

WRITE TO: CSVTC.CMTI@GMAIL.COM

Entry is limited to the first 50 participants only



The **Level 2 Laboratory Training On Semiconductor Packaging** was initiated in 2023 in collaboration with CMTI, ISSS and STARC. The first edition was held from **27 February to 3 March 2023**. Around 45+ participants from Industry, academia and the student community took part in this workshop. The workshop also consisted of 19 keynote lectures and a visit to the STARC MEMS facility. The Eyes-On & Hands-On training consisted of several packaging and characterization techniques, from dicing to sealing. The participants of the workshops expressed positive feedback and suggested more such training to benefit the semiconductor community.

REVIEWS

Very Good!!

It is a nice workshop to establish new techniques for packaging of semiconductor devices

INTERACTIVE HANDS ON SESSIONS
INFORMATIVE PRESENTATIONS
LEARN IT PROCESS FLOW OF SEMICONDUCTOR PACKAGING

I got to increase my knowledge two to three times. Thanks a lot for my Director and CMTI Director and whole team

It's a very informative workshop

I will request to CMTI, please try to provide this training every year and try to accumulate & advertise among all IITs & NITs and other engineering college.

Great learning from all of the speakers, especially on packaging on Day 3 & 4 is more connecting on advanced packaging.

It was a laboratory training on semiconductor packaging have provided very informative lectures by the faculty. I would like to thank and congratulate CMTI and their team for very nice arrangements and other things.

Thank you
It was a great experience of the lectures, work stations and BTD. All the technicians at BTD were so well structured and behaved. Thank you everyone and all the very best to CMTI.

The workshop was organized and followed flawlessly. The time dedicated to lectures could have been reduced and given to the laboratory sessions.

Overall, the efforts from all the members of CMTI and experts are appreciable.

Practical Hands On may be offered to feel and experience the experiences of CMTI in problem solving experiences. CMTI facilities and future technologies very useful to ignite new brains like school geer from class VIII to XII student for free to create more bent of mind and understanding for future readiness and technology need to work upon.

It was great learning at CMTI. Thank you for this opportunity!



This training will include expert talks and lectures from leading industry professionals and experienced academic faculty. It covers the latest trends and recent advancements in advanced packaging technologies with future perspectives

Why this workshop?

What will be covered?

EYES-ON & HANDS-ON PROCESSES

Wafer dicing	Wafer bonding
Wire bonding	Electroplating
Bond testing	E-beam welding
Flip chip bonding	Elec.
Leak testing	Characterization

COURSE FEE*

Industry: 30000 INR
R&D/Faculty: 20000 INR
Students: 10000 INR

FOR ISSS MEMBERS*

Industry: 25000 INR
R&D/Faculty: 15000 INR
Students: 8000 INR

* Exclusive of GST | GST: 18% Extra

Fee?

Register?

REGISTRATION



PAYMENT

